

FORM PTO-1449

INFORMATION DISCLOSURE CITATION

Attorney Docket:
4024-4011US2

Serial No.:

~~To Be Assigned~~ 10/817190

Applicant:

Keith Kang and John Trezza

Filing Date:

April 2, 2004

Group Art Unit:

~~To Be Assigned~~ 2839

U.S. PATENT DOCUMENTS

Examiner Initial	Patent Number	Issue Date	Name	Class	Sub-Class	Filing Date
kn	3,825,318		Croset et al.			August 10, 1972
	4,230,385		Ammon et al.			February 6, 1979
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	5,259,052		Briggs et al.			February 11, 1991
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	5,400,429		Ames et al.			August 8, 1994
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Examiner Initial	Patent Number	Publication Date	Country	Class	Sub-Class	Translation
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kn	Ayliffe, M.H., "Optomechanical, electrical and thermal packaging of large 2D optoelectronic device arrays for free-space optical interconnects", <i>SPIE</i> , Vol. 3490, pages 502-505.
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Examiner

K. NGUYEN

Date Considered

7/27/04

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP §609.

Draw line through citation if not in conformance and not considered.

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Examiner Initial	Patent Number	Issue Date	Name	Class	Sub-Class	Filing Date
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Examiner	<i>Knguyen</i>	Date Considered	<i>7/27/04</i>
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ku	Hayashi T. and Tsunetsugu H, "Optical Module with MU Connector Interface Using Self-alignment Technique by Solder-bump Chip Bonding", Electronic Components and Technology Conference, page 13-19, 1996.
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Examiner	K. Nguyen	Date Considered	7/27/04
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Examiner	<i>Nguyen</i>	Date Considered	<i>7/27/04</i>
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